

Dymax 3069P Fast Shallow Potting Compound and Sealant

Category : Polymer , Adhesive , Thermoset

Material Notes:

Shallow Potting and Sealing in Seconds
Features
UV cures in seconds to 1/4 inch deep
One component, no mixing
Solvent-free
Environmentally friendly
Excellent adhesion to most substrates
Description
UV curable potting materials are used for sealing electrical connectors, temperature probes and sensors in applications throughout the aerospace, electronic, electrical, industrial, defense and marine industries. Dymax potting compounds cure in seconds, on demand, and have very low shrinkage. See pages for a selection of Dymax UV curing lamps and conveyors which can lower production costs when used in conjunction with Dymax adhesives.
Dymax 3069P Fast Shallow Potting Compound and Sealant
Contains no (meth) acrylic acid; low V.O.C. Key Substrates: Metal Typical Use: Sensors

Order this product through the following link:

http://www.lookpolymers.com/polymer_Dymax-3069P-Fast-Shallow-Potting-Compound-and-Sealant.php

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